



# SGM8941/SGM8942

## 1.5MHz, Rail-to-Rail Input and Output Operational Amplifiers

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### GENERAL DESCRIPTION

The single SGM8941 and dual SGM8942 are high performance CMOS operational amplifiers optimized for low voltage operation. These devices operate from 1.8V to 5.5V single supply, consuming low quiescent current. They provide rail-to-rail input and output operation.

The SGM8941/2 offer impressive overall performance. They feature low offset, excellent CMRR and high linearity. These devices work well in low voltage and high quality systems, such as sensor amplification and sensor conditioning.

The SGM8941 is available in Green SOT-23-5 and SOIC-8 packages. The SGM8942 is available in Green SOIC-8 and MSOP-8 packages. They are specified over the extended -40°C to +85°C temperature range.

### FEATURES

- **Low Input Offset Voltage: 0.15mV (TYP)**
- **Low Input Voltage Noise: 38nV/ $\sqrt{\text{Hz}}$**
- **Gain-Bandwidth Product: 1.5MHz**
- **Slew Rate: 0.8V/ $\mu\text{s}$**
- **Rail-to-Rail Input and Output**
- **Supply Voltage Range: 1.8V to 5.5V**
- **Low Supply Current: 120 $\mu\text{A}$ /Amplifier (TYP)**
- **-40°C to +85°C Operating Temperature Range**
- **Small Packaging:**
  - SGM8941 Available in SOT-23-5 and SOIC-8 Packages
  - SGM8942 Available in MSOP-8 and SOIC-8 Packages

### APPLICATIONS

Data Acquisition  
Process Control  
Active Filter  
Test Equipment  
Mobile Phone  
Audio Processing  
Video Processing  
Headphone Amplifier  
Portable Equipment  
Broadband Communication

**PACKAGE/ORDERING INFORMATION**

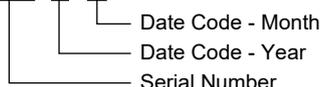
MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8941	SOT-23-5	-40°C to +85°C	SGM8941YN5G/TR	SBCXX	Tape and Reel, 3000
	SOIC-8	-40°C to +85°C	SGM8941YS8G/TR	SGM 8941YS8 XXXXX	Tape and Reel, 2500
SGM8942	SOIC-8	-40°C to +85°C	SGM8942YS8G/TR	SGM 8942YS8 XXXXX	Tape and Reel, 2500
	MSOP-8	-40°C to +85°C	SGM8942YMS8G/TR	SGM8942 YMS8 XXXXX	Tape and Reel, 3000

**MARKING INFORMATION**

NOTE: XX = Date Code. XXXXX = Date Code and Vendor Code.

**SOT-23-5**

**YYY X X**



**SOIC-8/MSOP-8**

**XXXXX**



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

**ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, +V<sub>S</sub> to -V<sub>S</sub> .....6V  
 Input Common Mode Voltage Range  
 ..... (-V<sub>S</sub>) - 0.1V to (+V<sub>S</sub>) + 0.1V  
 Junction Temperature .....+150°C  
 Storage Temperature Range .....-65°C to +150°C  
 Lead Temperature (Soldering, 10s).....+260°C  
 ESD Susceptibility  
 HBM.....8000V  
 MM.....400V

**RECOMMENDED OPERATING CONDITIONS**

Operating Temperature Range .....-40°C to +85°C

**OVERSTRESS CAUTION**

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any

conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

**ESD SENSITIVITY CAUTION**

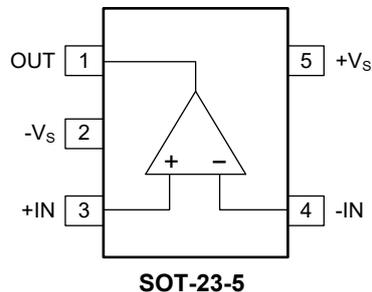
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

**DISCLAIMER**

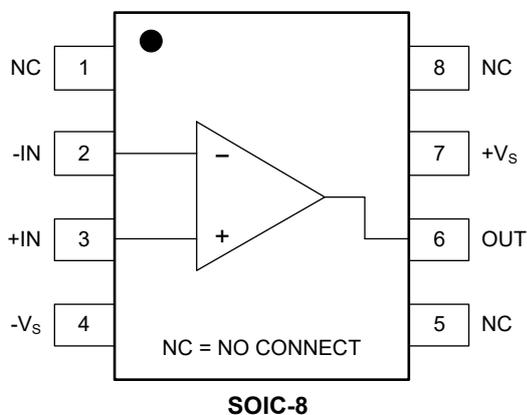
SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

**PIN CONFIGURATIONS**

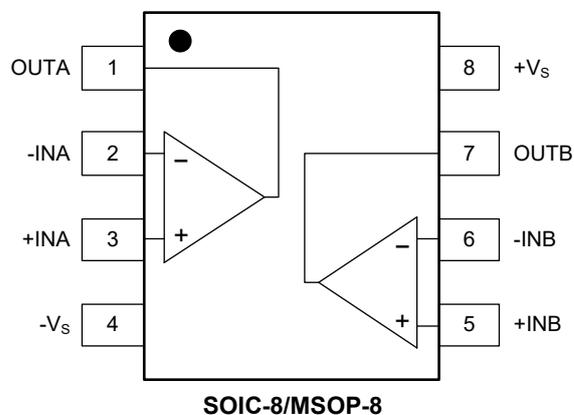
**SGM8941 (TOP VIEW)**



**SGM8942 (TOP VIEW)**



**SGM8942 (TOP VIEW)**



**ELECTRICAL CHARACTERISTICS**

( $V_S = 5.0V$ ,  $V_{OUT} = V_S/2$ , Full =  $-40^{\circ}C$  to  $+85^{\circ}C$ , typical values are at  $T_A = +25^{\circ}C$ , unless otherwise noted.)

PARAMETER	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
<b>DC Performance</b>						
Input Offset Voltage ( $V_{OS}$ )	$V_{CM} = V_S/2$	+25°C		0.15	0.9	mV
		Full			1.6	
Input Bias Current ( $I_b$ )		+25°C		3		pA
Input Offset Current ( $I_{OS}$ )		+25°C		3		pA
Input Offset Voltage Drift	$V_{CM} = V_S/2$	Full		3		$\mu V/^{\circ}C$
Open-Loop Voltage Gain ( $A_{OL}$ )	$R_L = 2k\Omega$ , $V_{OUT} = 0.2V$ to $4.8V$	+25°C	79	88		dB
		Full	76			
	$R_L = 10k\Omega$ , $V_{OUT} = 0.1V$ to $4.9V$	+25°C	80	90		
		Full	77			
<b>Input Characteristics</b>						
Input Common Mode Voltage Range ( $V_{CM}$ )		+25°C	-0.1		5.1	V
Common Mode Rejection Ratio (CMRR)	$V_{CM} = -0.1V$ to $5.1V$	+25°C	74	90		dB
		Full	71			
<b>Output Characteristics</b>						
Output Voltage Swing from Rail	$R_L = 2k\Omega$	+25°C		75	90	mV
		Full			110	
	$R_L = 10k\Omega$	+25°C		17	35	
		Full			55	
Output Short-Circuit Current ( $I_{SC}$ )	$R_L = 10\Omega$ to $V_S/2$	+25°C	26.5	35.0		mA
		Full	19.0			
<b>Power Supply</b>						
Quiescent Current/Amplifier	$I_{OUT} = 0mA$	+25°C		120	178	$\mu A$
		Full			205	
Power Supply Rejection Ratio (PSRR)	$V_S = 1.8V$ to $5.5V$ , $V_{CM} = 0.5V$	+25°C	77	85		dB
		Full	72			
<b>Dynamic Performance <sup>(1)</sup></b>						
Gain-Bandwidth Product (GBP)	$C_L = 100pF$ , $R_L = 2k\Omega$	+25°C		1.5		MHz
Slew Rate (SR)	$V_{OUT} = 2V_{P-P}$ , $A_V = 1$	+25°C		0.8		$V/\mu s$
Crosstalk	$f = 1kHz$	+25°C		110		dB
Settling Time to 0.1% ( $t_s$ )	$V_{OUT} = 200mV_{P-P}$ , $f = 1kHz$ , $A_V = 1$ , $C_L = 100pF$ , $R_L = 2k\Omega$	+25°C		2		$\mu s$
Overload Recovery Time	$R_L = 2k\Omega$ , $A_V = -50$	+25°C		3.5		$\mu s$
<b>Noise/Distortion Performance</b>						
Input Voltage Noise ( $e_n$ )	$f = 1kHz$	+25°C		38		$nV/\sqrt{Hz}$

NOTE: 1. Power supply bypassing is an effective method to clear up the noise at power supply, and the low impedance path to ground of decoupling capacitor will bypass the noise to GND. A  $10\mu F$  ceramic capacitor paralleled with a  $0.1\mu F$  ceramic capacitor is used. The ceramic capacitors should be placed as close as possible to  $+V_S$  pin. A large ground plane is also needed to ensure optimum performance.

**ELECTRICAL CHARACTERISTICS (continued)**

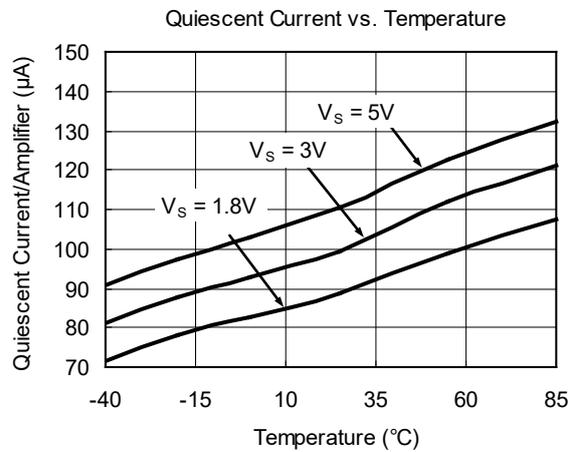
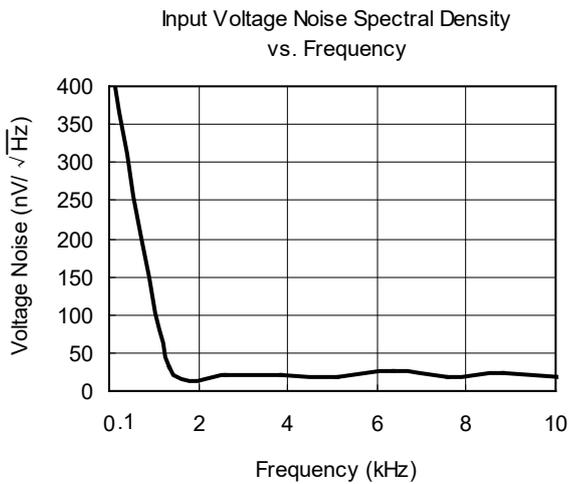
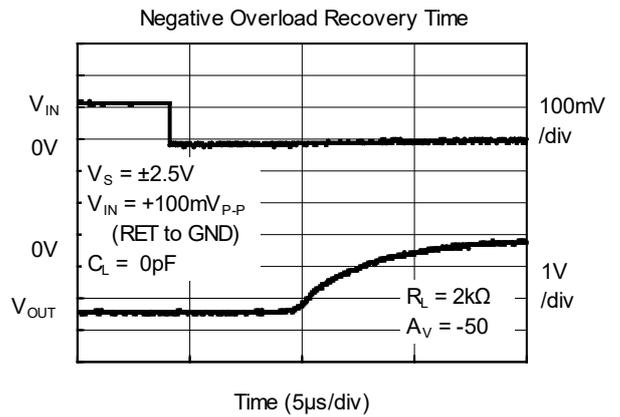
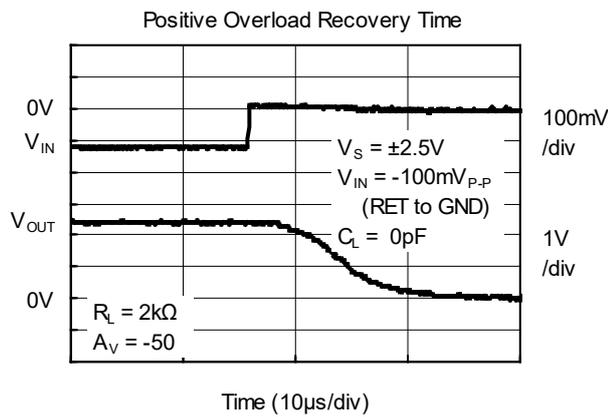
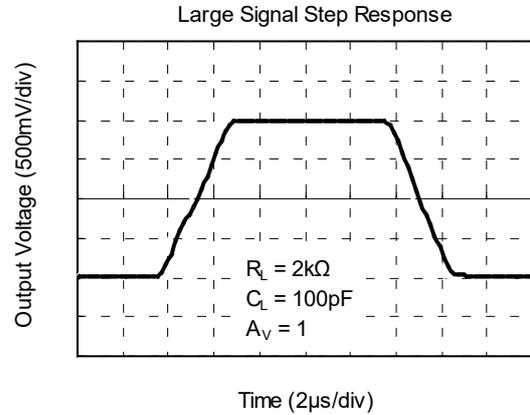
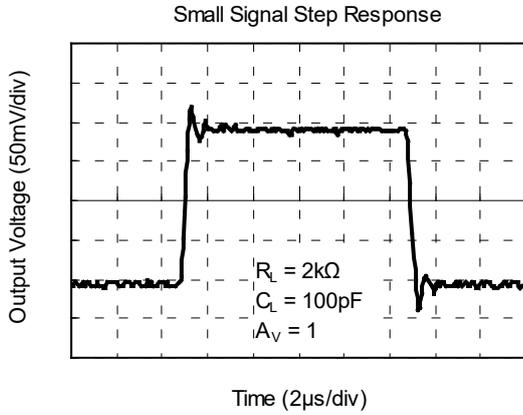
( $V_S = 1.8V$ ,  $V_{OUT} = V_S/2$ , Full =  $-40^\circ C$  to  $+85^\circ C$ , typical values are at  $T_A = +25^\circ C$ , unless otherwise noted.)

PARAMETER	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
<b>DC Performance</b>						
Input Offset Voltage ( $V_{OS}$ )	$V_{CM} = V_S/2$	+25°C		0.22	0.9	mV
		Full			1.55	
Input Bias Current ( $I_b$ )		+25°C		3		pA
Input Offset Current ( $I_{OS}$ )		+25°C		3		pA
Input Offset Voltage Drift	$V_{CM} = V_S/2$	Full		3.4		$\mu V/^\circ C$
Open-Loop Voltage Gain ( $A_{OL}$ )	$R_L = 2k\Omega$ , $V_{OUT} = 0.2V$ to $1.6V$	+25°C	76	88		dB
		Full	73			
	$R_L = 10k\Omega$ , $V_{OUT} = 0.1V$ to $1.7V$	+25°C	83	105		
		Full	80			
<b>Input Characteristics</b>						
Input Common Mode Voltage Range ( $V_{CM}$ )		+25°C	-0.1		1.9	V
Common Mode Rejection Ratio (CMRR)	$V_{CM} = -0.1V$ to $1.9V$	+25°C	69	85		dB
		Full	66			
<b>Output Characteristics</b>						
Output Voltage Swing from Rail	$R_L = 2k\Omega$	+25°C		42	62	mV
		Full			72	
	$R_L = 10k\Omega$	+25°C		9	25	
		Full			45	
Output Short-Circuit Current ( $I_{SC}$ )	$R_L = 10\Omega$ to $V_S/2$	+25°C	2.0	5.0		mA
		Full	1.1			
<b>Power Supply</b>						
Quiescent Current/Amplifier	$I_{OUT} = 0mA$	+25°C		105	168	$\mu A$
		Full			200	
<b>Dynamic Performance <sup>(1)</sup></b>						
Gain-Bandwidth Product (GBP)	$C_L = 100pF$ , $R_L = 2k\Omega$	+25°C		1.4		MHz
Slew Rate (SR)	$V_{OUT} = 1V_{P-P}$ , $A_V = 1$	+25°C		0.8		$V/\mu s$
Crosstalk	$f = 1kHz$	+25°C		110		dB
Settling Time to 0.1% ( $t_s$ )	$V_{OUT} = 200mV_{P-P}$ , $f = 1kHz$ , $A_V = 1$ , $C_L = 100pF$ , $R_L = 2k\Omega$	+25°C		2		$\mu s$
Overload Recovery Time	$R_L = 2k\Omega$ , $A_V = -50$	+25°C		2.5		$\mu s$
<b>Noise/Distortion Performance</b>						
Input Voltage Noise ( $e_n$ )	$f = 1kHz$	+25°C		36		$nV/\sqrt{Hz}$

NOTE: 1. Power supply bypassing is an effective method to clear up the noise at power supply, and the low impedance path to ground of decoupling capacitor will bypass the noise to GND. A  $10\mu F$  ceramic capacitor paralleled with a  $0.1\mu F$  ceramic capacitor is used. The ceramic capacitors should be placed as close as possible to  $+V_S$  pin. A large ground plane is also needed to ensure optimum performance.

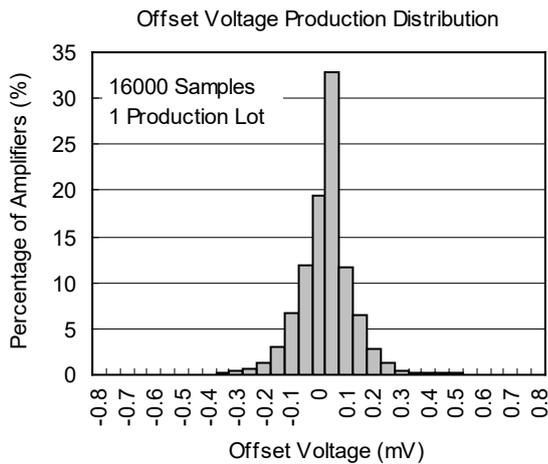
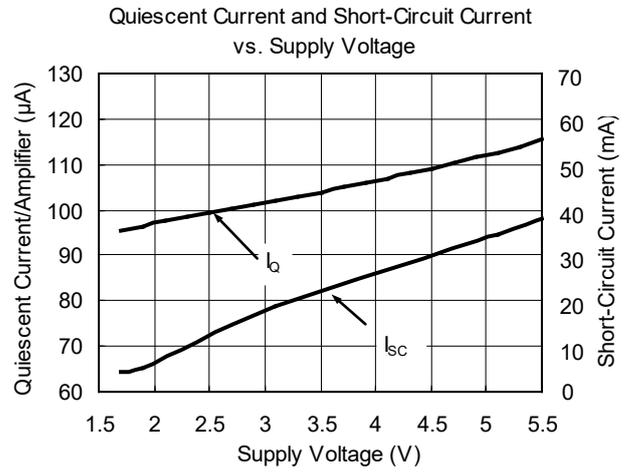
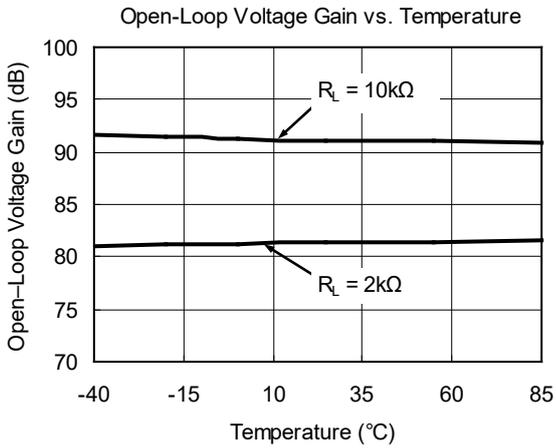
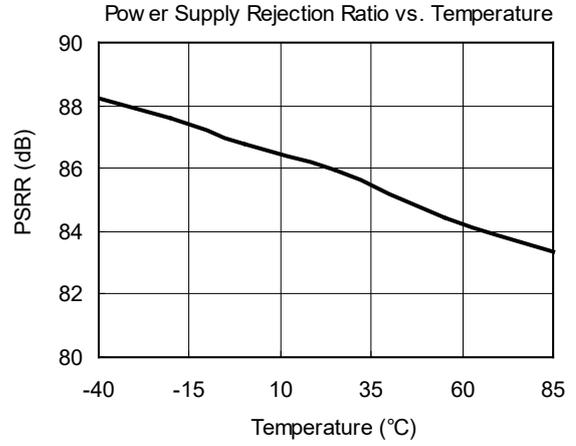
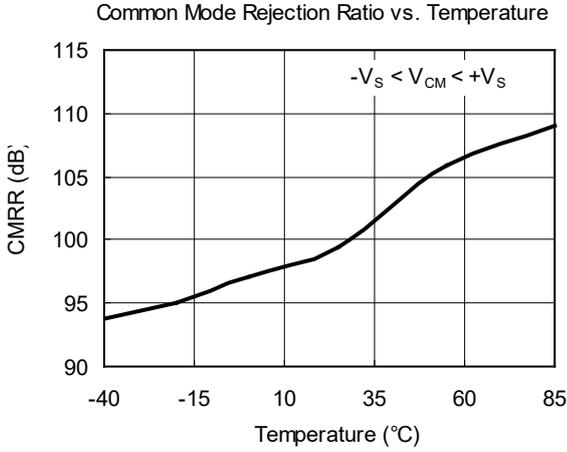
**TYPICAL PERFORMANCE CHARACTERISTICS**

At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ , unless otherwise noted.



**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ , unless otherwise noted.



**REVISION HISTORY**

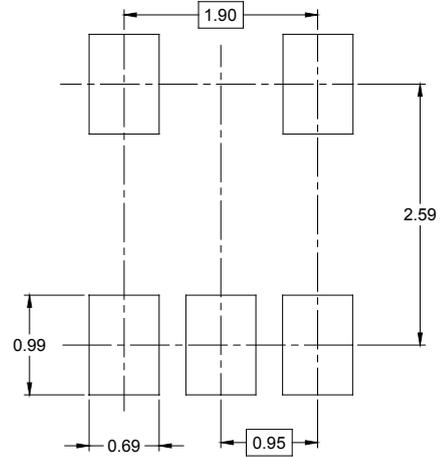
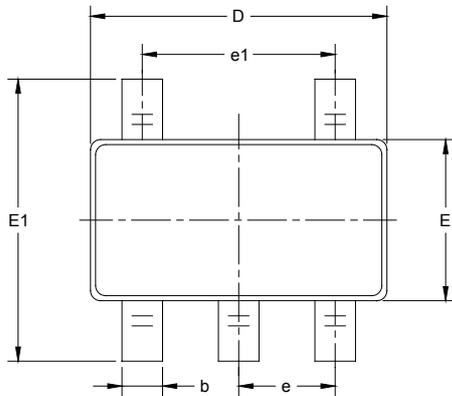
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

<b>Changes from Original (AUGUST 2012) to REV.A</b>	<b>Page</b>
Changed from product preview to production data .....	All

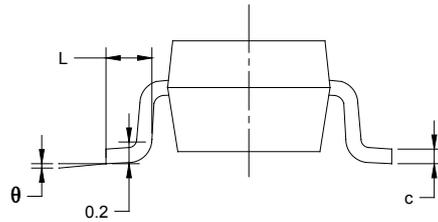
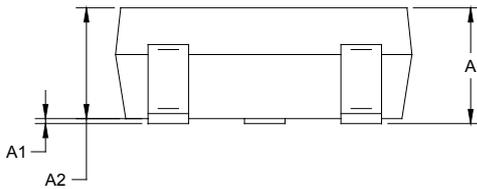
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PACKAGE OUTLINE DIMENSIONS

SOT-23-5



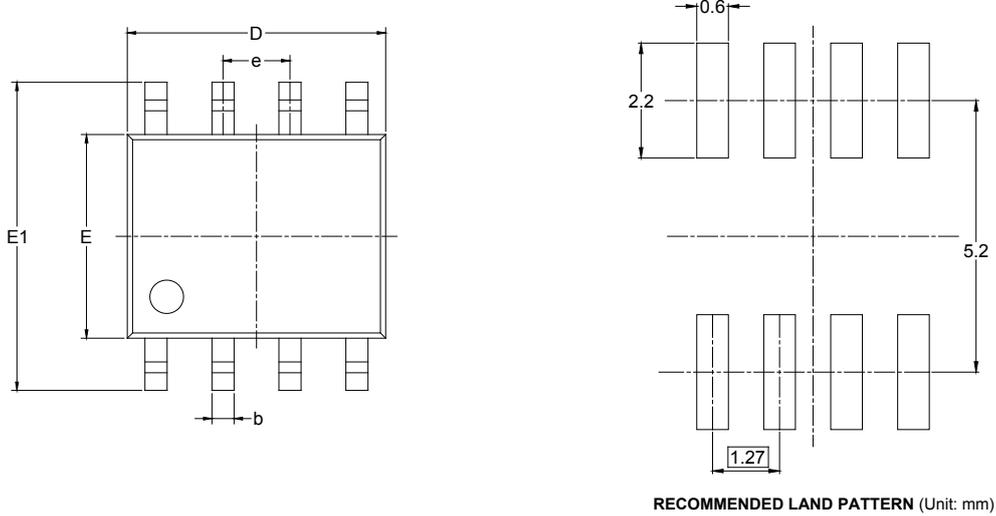
RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950 BSC		0.037 BSC	
e1	1.900 BSC		0.075 BSC	
L	0.300	0.600	0.012	0.024
$\theta$	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

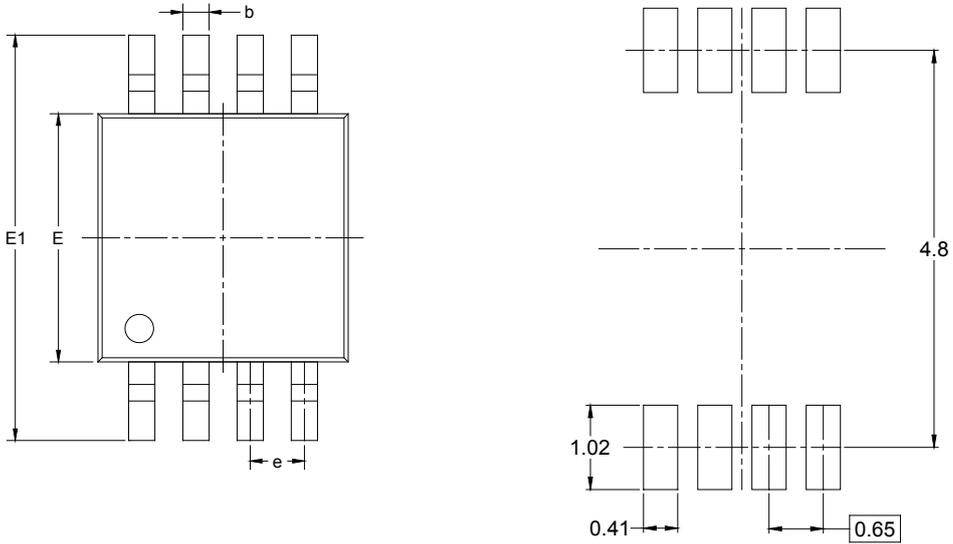
SOIC-8



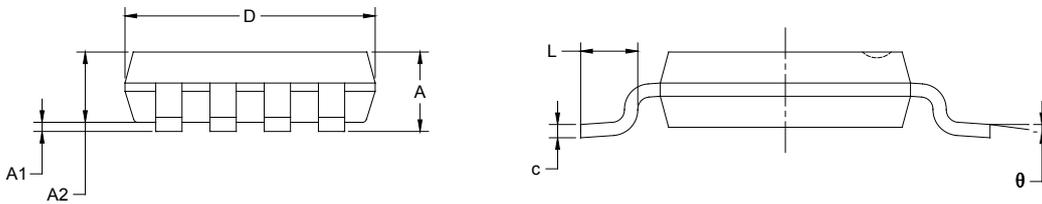
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
$\theta$	0°	8°	0°	8°

PACKAGE OUTLINE DIMENSIONS

MSOP-8



RECOMMENDED LAND PATTERN (Unit: mm)

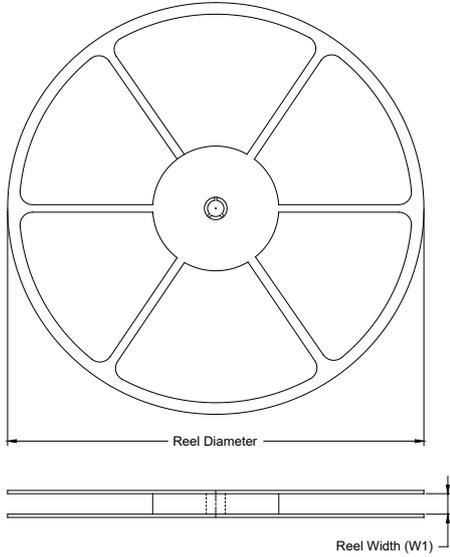


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
e	0.650 BSC		0.026 BSC	
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

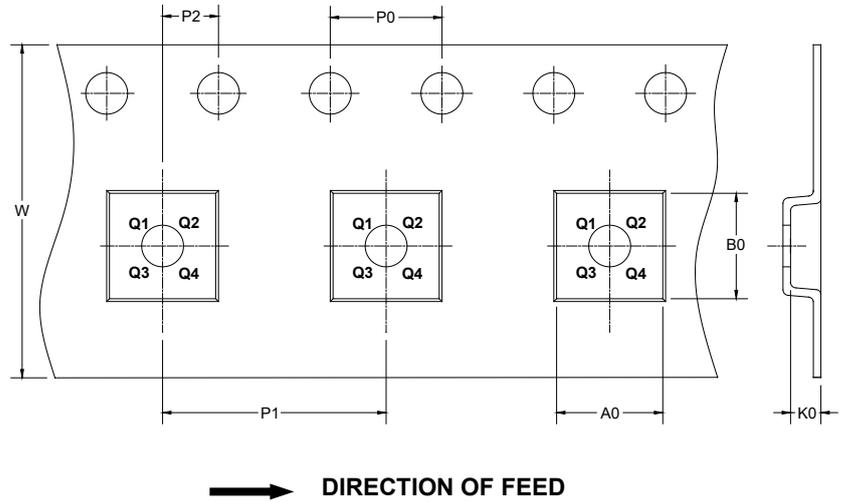
# PACKAGE INFORMATION

## TAPE AND REEL INFORMATION

### REEL DIMENSIONS



### TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

### KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-5	7"	9.5	3.20	3.20	1.40	4.0	4.0	2.0	8.0	Q3
SOIC-8	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1
MSOP-8	13"	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1

DD0001

# PACKAGE INFORMATION

## CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

## KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18
13"	386	280	370	5

DD0002